

Product Datasheet - Technical Specifications



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ME-5810 fast, Multifunctional Opto Digital and Counter Board

- Fast, multifunctional, expandable opto-I/O and counter board with data streaming (models /S) and interrupt control.
- For PCI-Express and 3 U CompactPCI/PXI.
- 16 or 32 digital inputs and 16 or 32 digital outputs, opto-isolated, and 3 isolated 16 bit counters.
- Inputs: 3...60 V variable, outputs: 15...30 V variable, isolation voltage up to 1 kV.
- Sink/source per port software-selectable, sink 50 mA/channel, source 180...370 mA/channel.
- Channels can have various functions within a firmware, for example single digital-I/O, streaming digital-I/O (models /S), frequency measurement, frequency output.
- Operating modes: Simple read, bitpattern comparator (compare) with interrupt, bitchange with interrupt.
- Expandable with add-on boards ME-5001 and ME-5004, for example 2 additional bidirectional 8 bit TTL ports.
- Replacement model for the well-known ME-8100.

Model	Opto in	Opto out	Opto isolated counters	Standard firmware functions	Streaming	Bus platform
ME-5810A PCIe	16	16	3		-	PCI-Express
ME-5810A cPCI	16	16	3	Single digital-I/O, streaming digital-I/O (models /S), frequency measurement [4 of the 16 inputs; 300 kHz], frequency output [4 of the 16 outputs; 3 kHz], bitpattern comparison with interrupt, bit-change with interrupt	-	3 HE CompactPCI/PXI
ME-5810A/S PCIe	16	16	3		yes	PCI-Express
ME-5810A/S cPCI	16	16	3		yes	3 HE CompactPCI/PXI
ME-5810B PCIe	32	32	3		-	PCI-Express
ME-5810B cPCI	32	32	3	Single digital-I/O, streaming digital-I/O (models /S), frequency measurement [8 of the 32 inputs; 300 kHz], frequency output [8 of the 32 outputs; 3 kHz], bitpattern comparison with interrupt, bit-change with interrupt	-	3 HE CompactPCI/PXI
ME-5810B/ PCIe	32	32	3		yes	PCI-Express
ME-5810B/S cPCI	32	32	3		yes	3 HE CompactPCI/PXI

A Specification

(Ambient temperature 25 °C)

PC Interface

PCI-Express Bus	32 bit, 33 MHz, 3.3 V, PCI-Express x1 specification version 2.0
CompactPCI Bus	32 bit, 33 MHz, 5 V, specification PICMG 2.0 R3.0
Plug&Play	is fully supported

Digital Input/Output (general)

Measured Quantity/Criterion	Condition/Explanation	Value
Ports ME-5810 (base board)	subdevice 0 (Single/Streaming)	16-bit input port opto-isolated
	subdevice 1 (Single/Streaming)	16-bit output port opto-isolated
Ports ME-5002 (plug-on board)	subdevice 0 (Single)	16-bit input port opto-isolated
	subdevice 1 (single)	16-bit output port opto-isolated
	single	software triggered read/write
	stream timer	timer controlled read/write of values via FIFO
	stream trigger sample	timer controlled read/write of values via FIFO
FIFO-size	interrupt	bit-pattern change, bit-pattern compare
	FIFO_IN	8192 values (16-bit-wide)
	FIFO_OUT	8192 values (16-bit-wide)

Transfer rate in streaming mode	between ME-5810 and PC	max. 25 MHz (cPCI) resp. 30 MHz (PCIe) (system-dependent)
Frequency input signal	symmetrical rectangular signal	max. 300 kHz
Frequency output signal	symmetrical rectangular signal	max. 3 kHz
	option „wraparound“	max. 3 kHz, without load for the Host PCs
Timer (CHAN-time)	input	30.30 ns...65 s (2..FFFFFFHex Ticks)
	output	0.15 ms...65 s (11000..FFFFFF-Hex Ticks)
Timer resolution	programmable	15.15 ns (1 Tick)
Ext. trigger inputs	ME-5810	DI_Ax, DO_Bx
Ext. trigger edges		Rising, falling, any
Input level	see the following tables	
Isolation voltage	U_{ISO} ($f = 60$ Hz, $t = 60$ s)	max. 1000 VAC _{rms}
Reference ground	isolated from PC ground	GND_EXT

Opto-Isolated Inputs

Static values

Conditions: TA=25 °C

Measured Quantity	Test Criterion	MIN	Type	MAX	Unit
$U_{in,H}$		3		60	V
$U_{in,L}$		0		2.2	V
R_{in}	$U_{in}=24$ V		4.3		kΩ
I_{in}	$U_{in}=24$ V		5.5	6	mA

Limiting Values

Measured Quantity /Criterion	Condition/Explanation	Value
URWM over-voltage protection for inputs	max. 600 W pulse power at a pulse width of 1 ms	64.4 V

Opto-Isolated Outputs

Conditions: $T_A=25\text{ }^\circ\text{C}$

Output-drivers	sink	2 x ULN2803 (ME-5810A)
		+ 2 x ULN2803 (ME-5002)
	source	2 x ISO1H811G (ME-5810A)
		+ 2 x ISO1H811G (ME-5002)
External supply	U_{ext}	15...30 V
	U_{Lmax}	U_{ext}

For further specifications see chapter sink driver resp. source driver

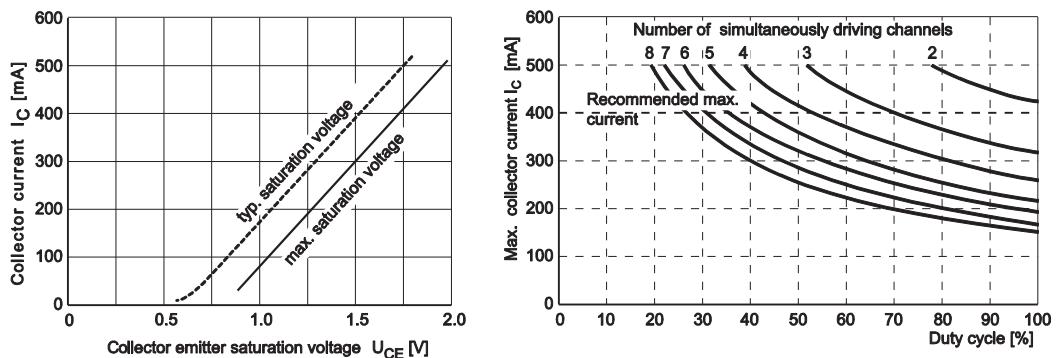
Sink Driver (UDN2803)

Measured Quantity	Test Criterion	MIN	Type	MAX	Unit
$I_{out}=I_c$ (output current)	per channel			50	mA
	See also characteristics curves in picture 23				
I_{CE0} (output leakage current)	$U_{CE}=50\text{ V}, T_A=25\text{ }^\circ\text{C}$ $U_{CE}=50\text{ V}, T_A=85\text{ }^\circ\text{C}$			50 100	μA
$U_{CE(SAT)}$ (collector emitter saturation voltage)	$I_{out}=350\text{ mA}$ $I_{out}=200\text{ mA}$ $I_{out}=100\text{ mA}$		1.3 1.1 0.9	1.6 1.3 1.1	V
I_R (clamp diode reverse current)	$U_R=50\text{ V}, T_A=25\text{ }^\circ\text{C}$ $U_R=50\text{ V}, T_A=85\text{ }^\circ\text{C}$			50 100	μA
U_F (clamp diode forward voltage)	$I_F=350\text{ mA}$			2.0	V
t_{on} (switch-on time)	$R_L=125\text{ }\Omega$, $U_{out}=50\text{ V}$, $C_L=15\text{ pFina}$		0.1	1	μs
t_{off} (switch-off time)	$R_L=125\text{ }\Omega$, $U_{out}=50\text{ V}$, $C_L=15\text{ pF}$		0.2	1	μs

Output current

The maximum current per output (I_c) depends of the saturation voltage U_{CE} and is limited by the power dissipation of the sum of the channels to $P_{tot}=1\text{ W}$ per chip:

$$P_{tot}=P_0+\dots+P_7 \leq 1\text{ W} \text{ (bei } 70\text{ }^\circ\text{C)}$$



Picture 23: Characteristic curves UDN2803

Source Driver (ISO1H811G)

(short-circuit proof with current limiting and temperature monitoring)

Voltage supply

Conditions: $U_{ext}=15\ldots 30\text{ V}$, $TJ=-25\ldots +125\text{ }^{\circ}\text{C}$

Measured Quantity	Test Criterion	MIN	Type	MAX	Unit
U_{OUT}	$U_{ext}=24\text{ V}$; 1 channel with $I_{out}=0,625\text{ A}$		23.8		V
$I_{OUT}/\text{channel}$	1 channel			625	mA
	16 channel			370	mA
	32 channel (with ME-5002)			180	mA
U_{USD} (undervoltage shutdown)		7		10.5	V
R_{ON} (resistance if output active)	$I_{out}=0.5\text{ A}$, $TJ=25\text{ }^{\circ}\text{C}$		150	200	$\text{m}\Omega$
	$I_{out}=0.5\text{ A}$, $TJ=125\text{ }^{\circ}\text{C}$		270	320	$\text{m}\Omega$
I_S (current consumption driver chip)	8 channels active per chip; without load		10	14	mA
$I_{L(off)}$ (output current in inactive state)	$U_{in}=U_{OUT}=0\text{ V}$,	0	5	30	μA

Switching Times

Measured Quantity	Test Criterion	MIN	Type	MAX	Unit
t_{on} (switch-on time)	RL=47 Ω, to 90 % U_{out}		64	120	μs
t_{off} (switch-off time)	RL=47 Ω, to 10 % U_{out}		89	120	μs
$dU_{out}/dt_{(on)}$ (slope on switch-on)	RL=47 Ω, up 10...30 % U_{out} , $U_{ext}=15$ V		1	2	V/ μs
$dU_{out}/dt_{(off)}$ (slope on switch-off)	RL=47 Ω, up 70...40 % U_{out} , $U_{ext}=15$ V		1	2	V/ μs

Limiting Values

Measured Quantity	Test Criterion	MIN	Type	MAX	Unit
T_{CSD} (housing switch-off temperature)		125	130	135	°C
T_{CR} (housing reset temperature)		110			°C
T_{TSD} (junction switch-off temperature)		150	175	200	°C
T_R (junction reset temperature)		135	1		°C
I_{lim} (DC-short-circuit current)	$U_{ext} = 24$ V, $R_L=10$ mΩ		1.1		A

Frequency Input/Output

Availability	alternative subdevice configuration via ME-iDC
Signal-form	rectangular

Frequency Measuring Channels

Measured Quantity/Criterion	Condition/Explanation	Value
Reference ground	isolated from PC ground	GND_EXT
Number of channels	ME-5810A (FI_AO...3)	4 inputs (opto-isolated)

	ME-5002 (FI_CO...3)	4 inputs (opto-isolated)
Input-level		see digital I/O
Input-current		see digital I/O
Period (T)	$T_{\min.} = T_{\min.\text{asym.}} = T_{\min.\text{sym.}}$ $T_{\max.\text{asym}}$ $T_{\max.\text{sym}}$	3.3 μ s (300 kHz) 16.25 s (0.06 Hz) 32.5 s (0.03 Hz)
Duty-cycle	variable, depending on T	measurable in steps of 1 tick
Resolution	1 tick	15.15 ns
Accuracy		\pm 15.15 ns
Operating modes		single

Pulse Generator Channels

Measured Quantity/Criterion	Condition/Explanation	Value
Reference ground	isolated from PC ground	GND_EXT
Number of channels	ME-5810A (FI_AO...3)	4 outputs (opto-isolated)
	ME-5002 (FI_CO...3)	4 outputs (opto-isolated)
Output level	sink or source driver	see digital I/O
Period (T)	$T_{\min.} = T_{\min.\text{asym.}} = T_{\min.\text{sym.}}$ $T_{\max.\text{asym}}$ $T_{\max.\text{sym}}$	0.3 ms (300 kHz) 16.25 s (0.06 Hz) 32.5 s (0.03 Hz)
Duty-cycle	variable, depending on T	to be set in steps of 1 tick
Resolution	1 tick	15.15 ns
Accuracy		\pm 15.15 ns
Operating modes		single

Counters

Number	3 x 16 bit (1 x 82C54)
Opto-isolation	yes (dimensioning of the I/O level for 24 V)
Counter-clock	up to 10 MHz by external source

...with Opto-Isolation

Measured Quantity/Criterion	Condition/Explanation	Value
Reference ground	isolated from PC ground	GND_EXT
External supply for opto-couplers	U_{ext}	24...30 V
Level for Counter Outputs (OUT_x)		
Type		"Open Collector"
U_{Lmax}		U_{ext}
I_{out}		max. 30 mA
Level for Counter Inputs CLK_x, Gate_x)		
Logic level	inverted by opto-couplers	low-active
I_F		$7.5 \text{ mA} \leq I_F \leq 10 \text{ mA}$
U_{IL}		max. 0.8 V
U_{IH}		24..30 V, max. U_{ext}

Interrupt

Measured Quantity/Criterion	Condition/Explanation	Value
Interrupt sources	passed directly to the PC	bit-pattern change bit-pattern compare

General Data

Measured Quantity/Criterion	Condition/Explanation	Value
Power supply	CompactPCI	+5 V (via PCI-Bus)
	PCI-Express	+3.3 V (via PCIe-Bus), +5 V (via Molex plug from PC power supply unit)
Current consumption	CompactPCI	0.8...1.2 A (full-load)
	PCI-Express	0.8...1.2 A (full-load)
Board dimensions (without slot bracket and connector)	CompactPCI	3 U CompactPCI board
	PCI-Express	162 mm x 98 mm

Connections	ST1	78-pin D-sub female socket
	I/Os der ME-5002	via ST1 of base board
Operating temperature		0 °C...70 °C
Storage temperature		-40 °C...100 °C
Air humidity		20 %...55 % (non-condensing)
Certification	CE	

B Pinout

Note: „ME-5810“ represents all models of the ME-5810 series.

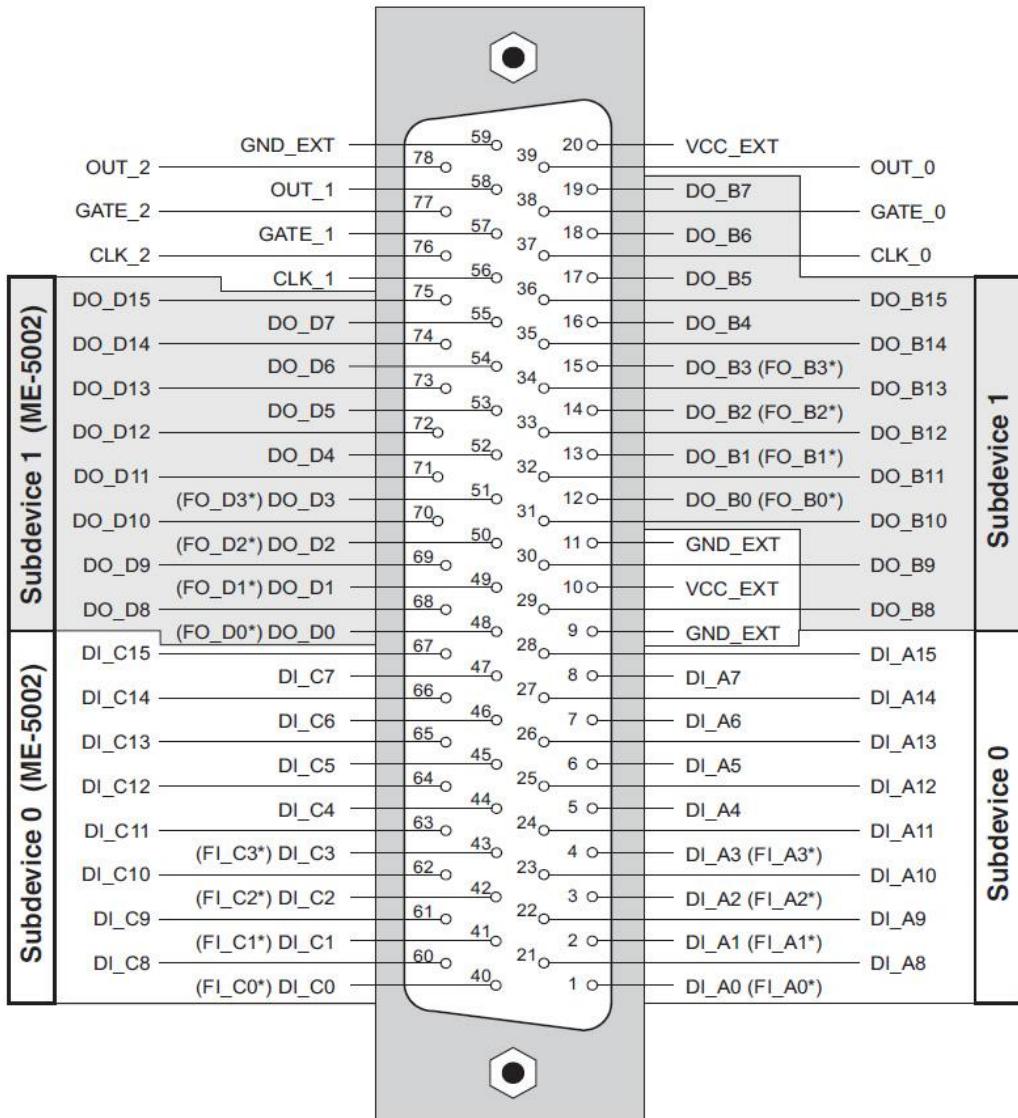
Legend for pinouts:

Name	Function
DI_A0..15	digital inputs of ME-5810 (subdevice 0)
DO_B0..15	digital outputs of ME-5810 (subdevice 1)
DI_C0..15*	digital inputs of ME-5002 (subdevice 0)
DO_D0..15*-	digital inputs of ME-5002 (subdevice 1)
CLK_0..2	clock inputs for counters
GATE_0..2	gate inputs for counters (low-active)
OUT_0..2	Counter outputs (type "Open-Collector")
FI_A0..3	frequency measurement inputs of ME-5810 (subdevice 0, alternative configuration)
FO_B0..3	pulse generator outputs of ME-5810 (subdevice 1, alternative configuration)
FI_C0..3*	frequency measurement input of ME-5002 (subdevice 0, alternative configuration)
FO_D0..3*	pulse generator output of ME-5002 (subdevice 1, alternative configuration)
VCC_EXT	VCC input for ext. power supply of isolated ports, U_{ext} typ. 24 VDC
GND_EXT	reference ground for isolated ports (isolated from PC ground)

Note: In the configuration “pulse generator” (FO) do not forget to take care of the unused pins DO_B4..15 (ME-5810) and DO_D4..15 (ME-5002). When used as sink drivers they are in high-impedance state, when used as source drivers they are connected to ground!

*These signals are only available in combination with the plug-on board ME-5002 (note: ME-5810B = ME-5810 + ME-5002)

B1 78-pin D-Sub (ST1) — ME-5810



Picture 24: 78-pin D-sub female connector ME-5810 (ST1)

*These pins can only be used as frequency measurement inputs (FI_x) resp. pulse generator outputs (FO_x) after appropriate configuration of the corresponding subdevice with the ME-iDC. The remaining pins of the digital ports cannot be used for digital-I/O.